

•General Description

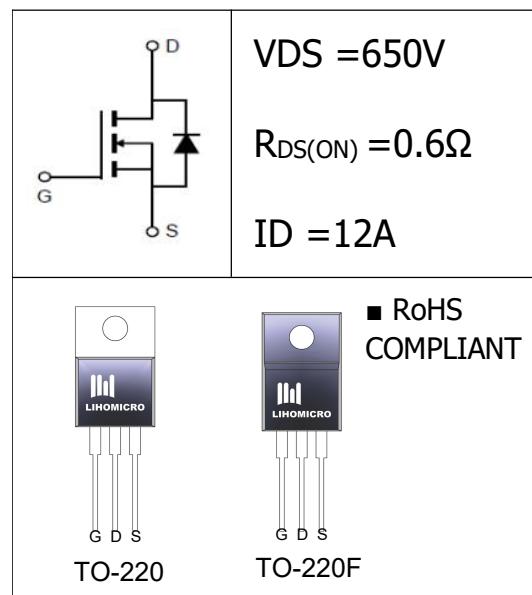
The Power MOSFET LH12N65F which has the low $R_{DS(on)}$,low gate charge,fast switching and excellent avalanche characteristics.This device offers extremely fast and robust body diode,and is suitable for telecom and power supplies.

•Features

- Low Thermal Resistance
- Fast Switching
- High Input Resistance

•Application

- LED/LCD/PDP TV and monitor Lighting
- Power Supplies


•Ordering Information:

Part number	LH12N65F	
Package	TO-220F	TO-220
Basic ordering unit (pcs)	1000	1000
Normal Package Material Ordering Code	LH12N65FF-T0220F-TU	LH12N65FT-T0220-TU
Halogen Free Ordering Code	LH12N65FF-T0220F-TU -HF	LH12N65FT-T0220-TU-HF

•Absolute Maximum Ratings (TC =25°C)

PARAMETER	SYMBOL	Value		UNIT
Drain-Source Breakdown Voltage	BV _{DSS}	650		V
Gate-Source Voltage	V _{GS}	±30		V
Continuous Drain Current TC = 25°C TC = 100°C	I _D	12		A
		7.5		
Pulsed drain current (TC = 25°C, tp limited by Tjmax) ¹	I _{DM}	48		A
Single Pulse Avalanche Energy ²	E _{AS}	720		mJ
Power Dissipation(TC=25°C)	P _D	TO-220F: 51	TO-220: 225	W
Junction Temperature	T _J	-55~+150		°C
Storage Temperature	T _{STG}	-55~+150		°C

•Electronic Characteristics

PARAMETER	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	650	--	--	V
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.0	--	4.0	V
Drain-source On Resistance ³	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 6A$	--	0.6	0.7	Ω
Drain-Source Leakage Current	I_{DSS}	$V_{DS} = 650V, V_{GS} = 0V, T_J = 25^\circ C$	--	--	1	μA
		$V_{DS} = 650V, V_{GS} = 0V, T_J = 125^\circ C$	--	--	10	
Gate-Source Leakage Current	I_{GSS}	$V_{GS} = \pm 30$	--	--	± 100	nA
Forward Transconductance ³	g_{fs}	$V_{DS} = 15V, I_D = 6A$	--	--	11	S
Input Capacitance	C_{iss}	$V_{GS} = 0V, V_{DS} = 25V, f = 1.0MHz$	1000	1970	2400	pF
Output Capacitance	C_{oss}		50	180	250	
Reverse transfer Capacitance	C_{rss}		5	16	30	
Turn -Off Delay Time ³	$T_{d(off)}$	$V_{DD} = 325V, R_G = 25\Omega$	--	62	--	ns
Total Gate Charge	Q_g	$I_D = 12A, V_{DS} = 520V, V_{GS} = 10V$	--	40	--	nC
Gate-to-Source Charge	Q_{gs}		--	10.4	--	
Gate-to-Drain Charge	Q_{gd}		--	14	--	
Continuous Diode Forward Current	I_s		--	--	12.0	A
Pulsed Diode Forward Current	I_{SM}		--	--	48.0	A
Diode Forward Voltage	V_{SD}	$T_J = 25^\circ C, I_S = 12A, V_{GS} = 0V$	--	--	1.4	V
Reverse Recovery Time	trr	$I_f = I_s, dI_f/dt = 100A/\mu s$	--	650	--	ns
Reverse Recovery Charge	Q_{rr}		--	4.2	--	μC

•Thermal Characteristics

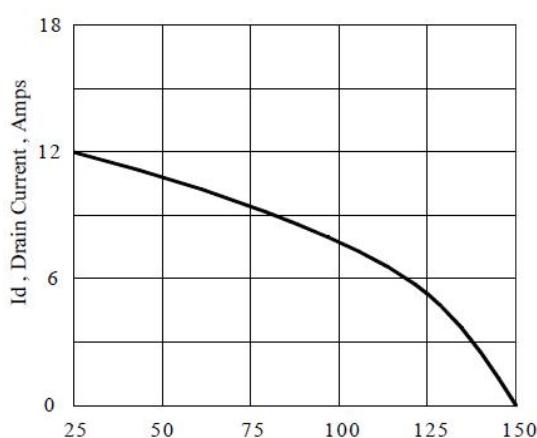
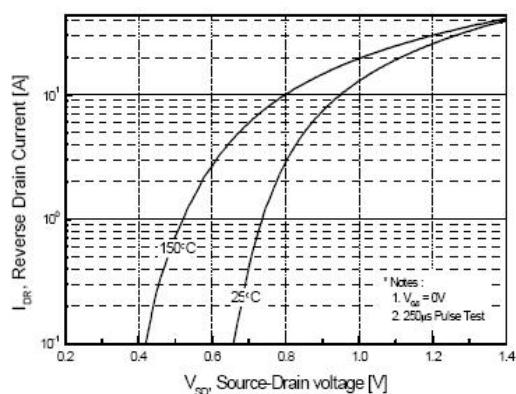
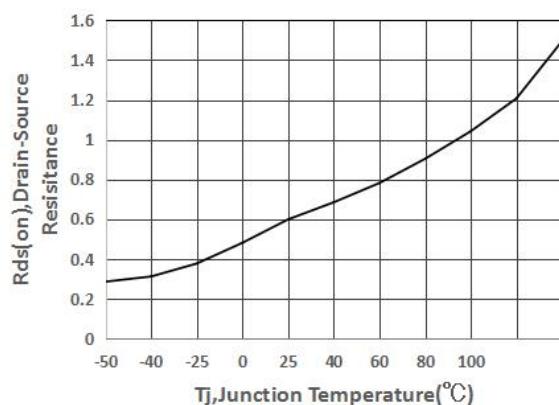
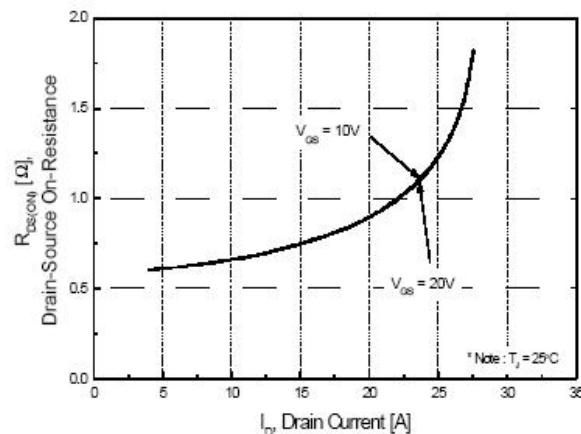
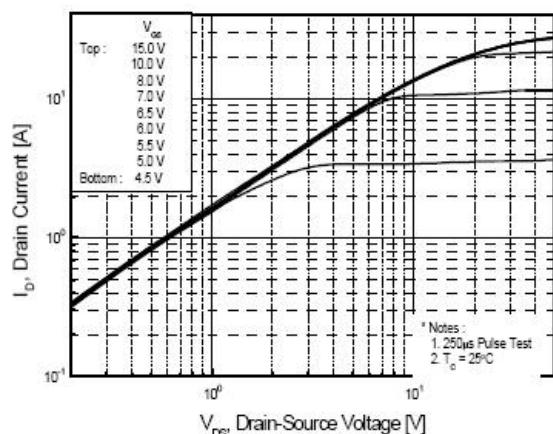
PARAMETER	SYMBOL	MAX		UNIT
		TO-220F	TO-220	
Thermal Resistance Junction-case	R_{thJC}	2.5	0.56	$^\circ C/W$
Thermal Resistance Junction-ambient	R_{thJA}	62.5	62.5	$^\circ C/W$

Notes:

1.Repetitive Rating: Pulse width limited by maximum junction temperature.

2. $I_{AS} = 12A, V_{DD} = 50V, R_G = 25\Omega, L = 11\mu H, T_J = 25^\circ C$

3. Pulse Test : Pulse width $\leq 300\mu s$, Duty cycle $\leq 2\%$

•Typical Characteristics


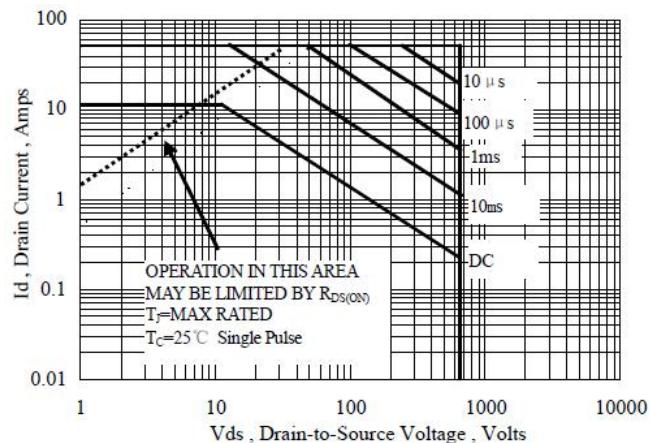
•Typical Characteristics (cont.)


Fig6-1 Maximum Safe Operating Area
(TO-220)

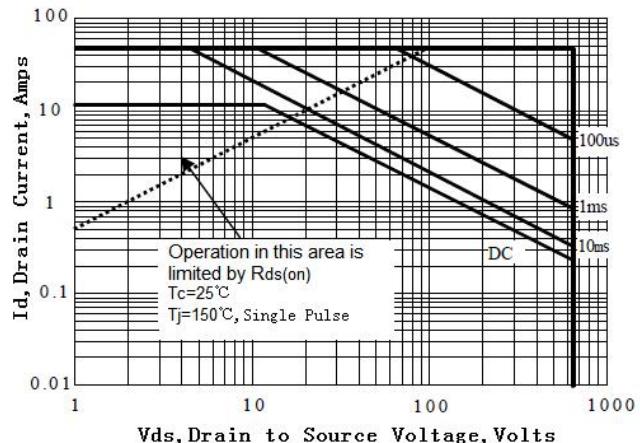
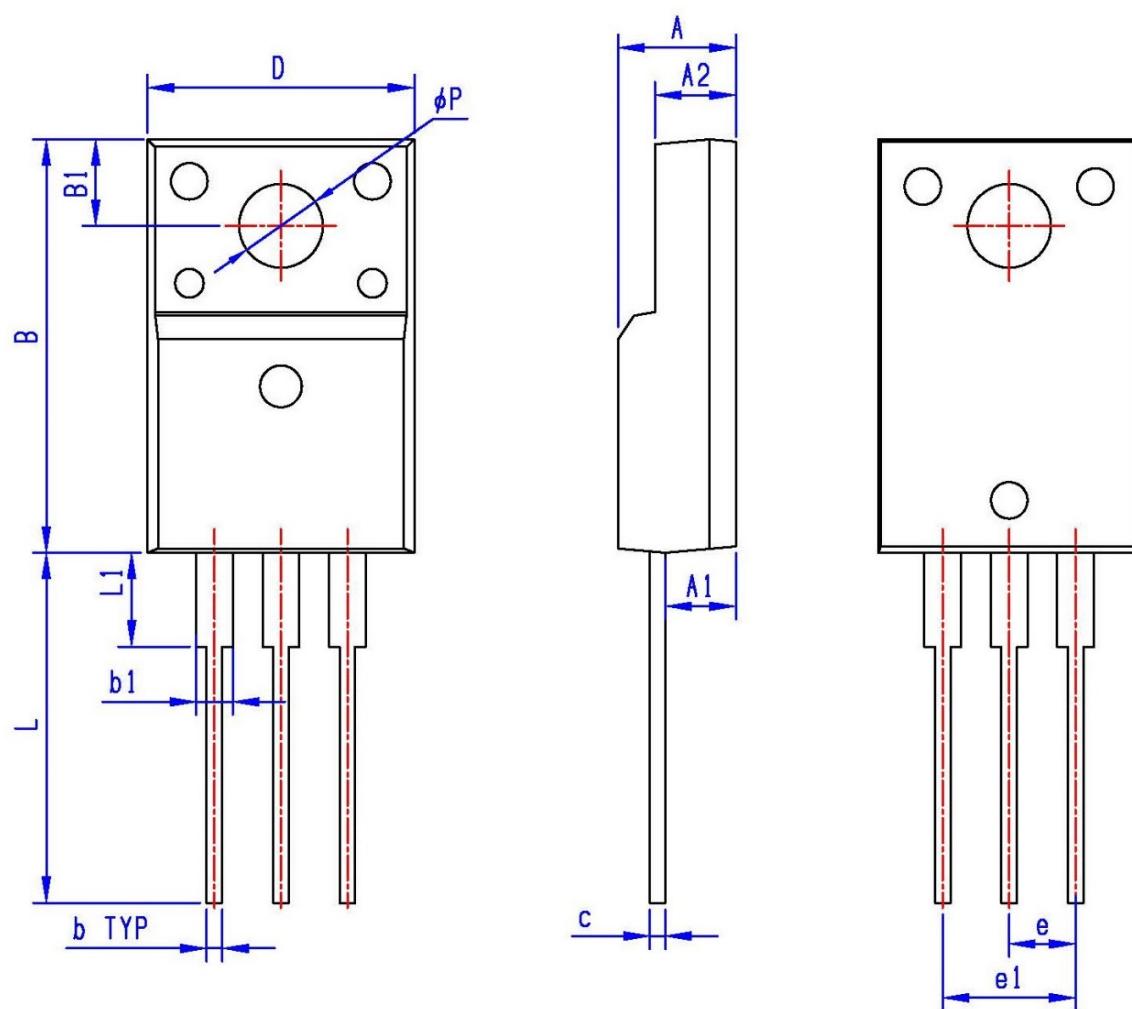


Fig6 -2 Maximum Safe Operating Area
(TO-220F)

•Dimensions (TO-220F)

UNIT:mm

SYMBOL	min	max	SYMBOL	min	max
A	4.40	4.90	B1	2.90	3.70
A1	2.40	3.00	e	2.40	2.70
A2	2.30	3.00	e1	4.95	5.25
b	0.60	0.90	L	12.40	14.20
b1	1.10	1.70	L1	2.40	3.40
c	0.40	0.70	ØP	2.90	3.50
D	9.80	10.60			
B	15.40	16.40			



•Dimensions (TO-220)

UNIT:mm

SYMBOL	min	max	SYMBOL	min	max
A	4.25	4.85	B1	2.60	3.00
A1	2.30	3.00	e	2.40	2.70
A2	1.20	1.40	e1	4.95	5.25
b	0.60	0.90	L	12.60	14.40
b1	1.10	1.70	L1	2.40	4.00
c	0.40	0.70	øP	3.50	3.90
D	9.80	10.60			
B	15.20	16.20			

